MOSFET - Power, Single N-Channel, TOLL 60 V, 0.9 mΩ, 422 A

NVBLS001N06C

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Lowers Switching Noise/EMI
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage	Э		V _{GS}	±20	V
Continuous Drain		T _C = 25°C	I _D	422	Α
Current R _{θJC} (Note 2)	Steady	T _C = 100°C		298	
Power Dissipation	State	T _C = 25°C	P_{D}	284	W
R _{θJC} (Note 2)		T _C = 100°C		142	
Continuous Drain	Steady State	T _A = 25°C	I _D	51	Α
Current R _{0JA} (Notes 1, 2)		T _A = 100°C		36	
Power Dissipation R _{0JA} (Notes 1, 2)		T _A = 25°C	P_{D}	4.2	W
		T _A = 100°C		2.1	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	900	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	236	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 39 A)			E _{AS}	1640	mJ
Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	0.53	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	36	

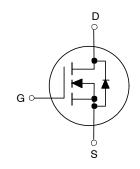
- 1. Surface-mounted on FR4 board using a 1 in2 pad size, 2 oz. Cu pad.
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
60 V	0.9 mΩ @ 10 V	422 A	





H-PSOF8L CASE 100CU

ORDERING INFORMATION

Device	Package	Shipping [†]
NVBLS001N06C	H-PSOF8L (Pb-Free)	2000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Table 1. ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Cond	litions	Min	Тур	Max	Units
OFF CHARACTERISTICS				·			.1
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 562 μA, ref to 25°C			26		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	T _J = 25°C			10	μΑ
			T _J = 125°C			100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _O	_{as} = 20 V			100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_{D}$	= 562 μΑ	2.0	2.8	4.0	V
Negative Threshold Temperature Coefficient	V _{GS(th)} /T _J	I _D = 562 μA, re	ef to 25°C		9.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I	D = 80 A		0.75	0.9	mΩ
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 80 A			290		S
CHARGES & CAPACTIANCES	•						
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V}, f = 10 \text{ kHz}$			11575		pF
Output Capacitance	C _{oss}				5973		pF
Reverse Transfer Capacitance	C _{rss}				76		pF
Total Gate Charge	Q _{G(tot)}	$V_{GS} = 10 \text{ V}, V_{DS} = 30 \text{ V},$ $I_{D} = 80 \text{ A}$			143		nC
Threshold Gate Charge	Q _{G(th)}				31		nC
Gate-to-Source Charge	Q_{gs}				54		nC
Gate-to-Drain Charge	Q_{gd}				13		nC
SWITCHING CHARACTERISTICS, V _{GS} = 10	0 V (Note 3)						
Turn-On Delay Time	t _{d(on)}	V_{GS} = 10 V, V_{DS} = 30 V, I_{D} = 80 A, R_{G} = 6 Ω			34		ns
Rise Time	t _r				53		ns
Turn-Off Delay Time	t _{d(off)}				119		ns
Fall Time	t _f				91		ns
DRAIN-SOURCE DIODE CHARACTERIST	ics						
Forward Diode Voltage	V_{SD}	I _S = 80 A, V _{GS} = 0 V	T _J = 25°C		0.79	1.2	V
	I _S = 80 A, \	I _S = 80 A, V _{GS} = 0 V	T _J = 125°C		0.66		V
Reverse Recovery Time	t _{rr}	V_{GS} = 0 V, dI_S/d_t = 100 A/ μ s, I_S = 56 A			120		ns
Charge Time	t _a				60		ns
Discharge Time	t _b				60		ns
Reverse Recovery Charge	Q _{rr}				322		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS

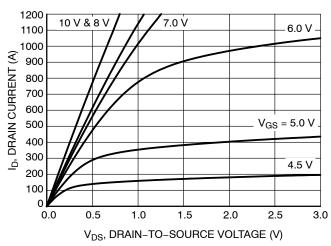


Figure 1. On-Region Characteristics

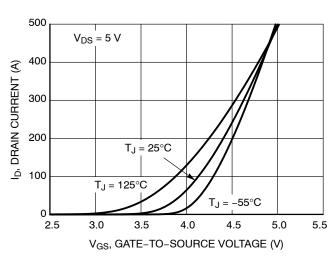


Figure 2. Transfer Characteristics

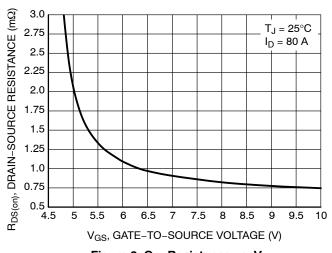


Figure 3. On–Resistance vs. V_{GS}

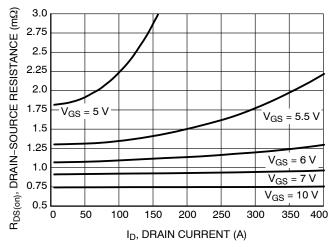


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

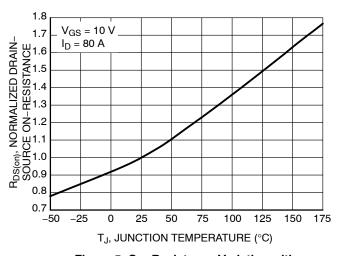


Figure 5. On–Resistance Variation with Temperature

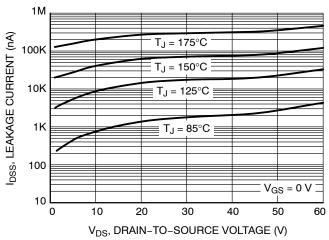


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

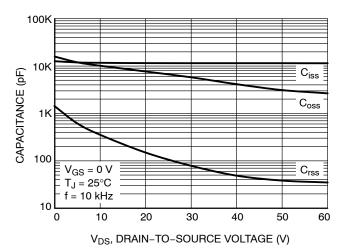


Figure 7. Capacitance Variation

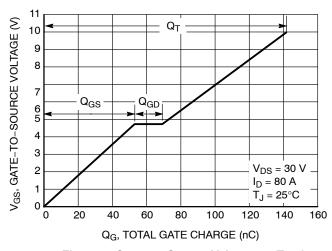


Figure 8. Gate-to-Source Voltage vs. Total Gate Charge

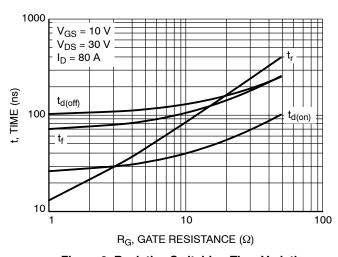


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

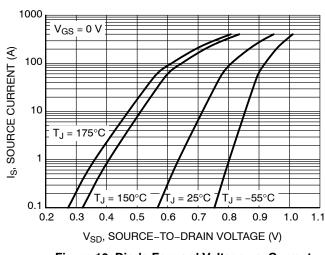


Figure 10. Diode Forward Voltage vs. Current

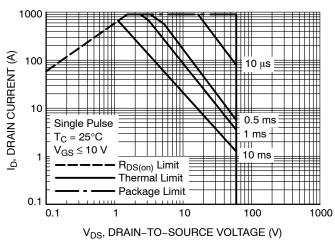


Figure 11. Maximum Rated Forward Biased Safe Operating Area

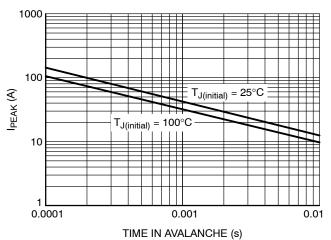


Figure 12. Avalanche Characteristics

TYPICAL CHARACTERISTICS

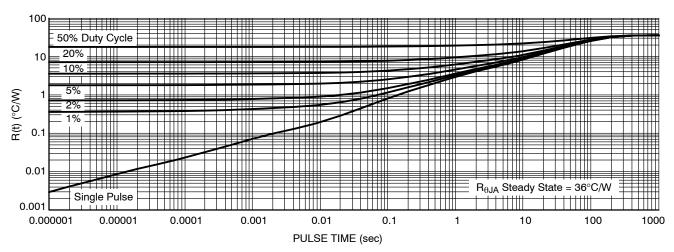
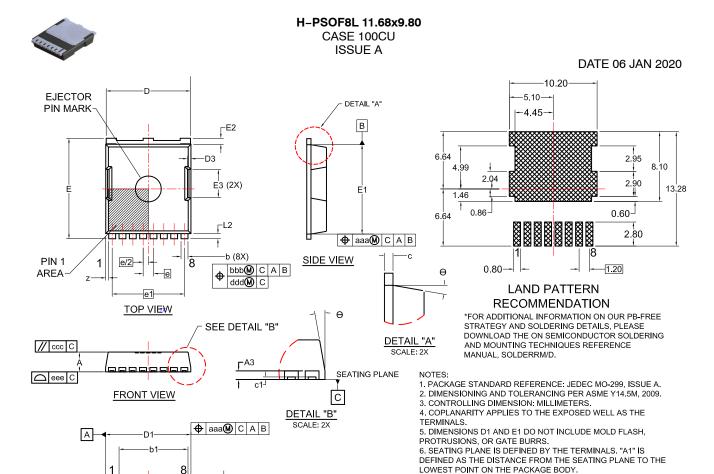


Figure 13. Thermal Characteristics (Junction-to-Ambient)



DIM	MILLIMETERS			
5	MIN.	NOM.	MAX.	
Α	2.20	2.30	2.40	
A3	0.40	0.50	0.60	
b	0.70	0.80	0.90	
b1		8.00 REF	-	
С	0.40	0.50	0.60	
c1	0.10			
D	9.70	9.80	9.90	
D1	9.80	9.90	10.00	
D2	4.73 BSC			
D3	0.40 REF			
D4	3.75 BSC			
D5	_	1.20		
D6	7.40	7.50	7.60	
D7	(8.30)			
E	11.58	11.68	11.78	
E1	10.28	10.38	10.48	
E2	0.60	0.70	0.80	
E3	3.30 REF			

E4

DIM	MILLIMETERS				
Divi	MIN.	NOM.	MAX.		
е	1.20 BSC				
e/2	(0.60 BSC	;		
e1		3.40 BSC	;		
K	1.50	1.57	1.70		
L	1.90	2.00	2.10		
L2	0.50	0.60	0.70		
Z	0.35 REF				
θ	0°		12°		
aaa	0.20				
bbb	0.25				
ccc	0.20				
ddd	0.20				
eee	0.10				
E5	-	3.30	_		
E6		0.65	_		
E7	7.15 REF				
E8	6.55 6.65 6.75				
E9	5.89 BSC				
E10	5.19 BSC				

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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H.A.A.A.A.A.A

|--D5 (3X)

D4 -

-D7

BOTTOM VIEW

E10

E9

| E8

L

-0.10 E4 (2X)

E5 (2X) ⊢E6 (2X)

Α

WW

ZΖ

GENERIC
MARKING DIAGRAM*

AYWWZZ

XXXXXXXX

= Year

= Work Week

XXXX = Specific Device Code

= Assembly Location

= Assembly Lot Code

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